Application Note: SY81052



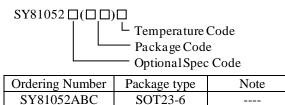
High Efficiency, Fast Response, 2.0A, 18V Input Synchronous Step Down Regulator

General Description

The SY81052 is a high efficiency, synchronous stepdown DC/DC converter capable of delivering 2A load current. The SY81052 operates over a wide input voltage range from 4.2V to 18V and integrates main switch and synchronous switch with very low $R_{DS(ON)}$ to minimize the conduction loss.

The SY81052 adopts the instant PWM architecture to achieve fast transient responses for high step down applications and high efficiency at light loads. In addition, it operates at pseudo-constant frequency of 500kHz to minimize the size of inductor and capacitor.

Ordering Information



- Low $R_{DS(ON)}$ for Internal Switches (Top/Bottom): $130m\Omega/105m\Omega$
- 4.2-18V Input Voltage Range
- 2A Output Current Capability
- 500kHz Switching Frequency Minimize the External Components
- Stable with $10 \,\mu\text{F}\,\text{C}_{\text{OUT}}$ and $2.2 \,\mu\text{H}$ Inductor
- Instant PWM Architecture to Achieve Fast Transient Responses
- Internal Soft-start Limits the Inrush Current
- Cycle-by-cycle Peak/Valley Current Limitation
- Hic-cup Mode Output Short Circuit Protection
- Thermal Shutdown with Auto Recovery
- Compact Package SOT23-6

Applications

- Set Top Box
- Portable TV
- DSL Modem
- LCD TV
- IP CAM
- Networking

Typical Application

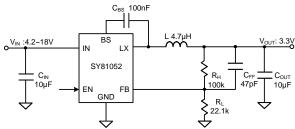


Figure1. Schematic Diagram

V _{OUT}	L	C _{OUT} [µF]			
[V]	[µH]	4.7	10	22	
1.2	2.2			٧	
1.2	3.3		☆	٧	
2.2	2.2		V	V	
3.3	4.7		☆	V	
5	3.3		V	V	
5	6.8		\$	V	

Note: '☆ ' means recommended for most applications.

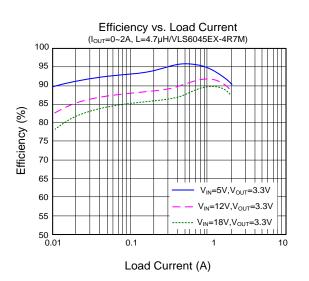
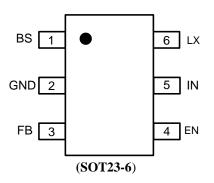


Figure2. Efficiency vs. Load Current



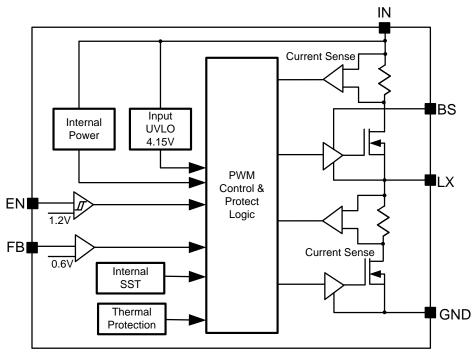
Pin-out (top view)



Top mark: **Q9xyz** (Device code: **Q9**, *x=year code*, *y=week code*, *z= lot number code*)

Pin Name	Pin Number	Pin Description			
BS	1	Boot-strap pin. Supply high side gate driver. Connect a 0.1 µF ceramic capacitor between the BS and the LX pin.			
GND	2	Power ground pin.			
FB	3	Output feedback pin. Connect this pin to the center point of the output resistor divider (as shown in Figure 1) to program the output voltage: $V_{OUT}=0.6 \times (1+R_H/R_L)$.			
EN	4	Enable control. Pull high to turn on. Do not leave this pin floating.			
IN	5	Input pin. Decouple this pin to the GND pin with at least a 10 µF ceramic capacitor.			
LX	6	Inductor pin. Connect this pin to the switching node of inductor.			

Block Diagram





Absolute Maximum Ratings (Note 1)

$\mathbf{\Theta}$	
Supply Input Voltage	0.3V to 19V
LX, EN Voltage	-0.3V to V_{IN} + 0.3V
FB, BS-LX Voltage	0.3V to 4V
Power Dissipation, $P_D @ T_A = 25 \ C \ SOT 23-6$,	1W
Package Thermal Resistance (Note 2)	
$\theta_{_{JA}}$	100 ℃/W
$\theta_{_{JC}}$	
Junction Temperature Range	
Lead Temperature (Soldering, 10 sec.)	260 °C
Storage Temperature Range	65 ℃ to 150 ℃
Dynamic LX voltage in 10ns duration (Note3)	

Recommended Operating Conditions (Note 3)

Supply Input Voltage	4 2V to 18V
Junction Temperature Range	40 °C to 125 °C
Ambient Temperature Range	40 ℃ to 85 ℃



Electrical Characteristics

 $(V_{IN} = 12V, V_{OUT} = 3.3V, L = 4.7 \mu H, C_{OUT} = 10 \mu F, T_A = 25 \text{ C}, I_{OUT} = 1A \text{ unless otherwise specified})$

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Input Voltage Range	V _{IN}		4.2		18	V
Input UVLO Threshold	V _{UVLO}				4.15	V
Input UVLO Hysteresis	V _{HYS}			0.6		V
Quiescent Current	IQ	$I_{OUT}=0, V_{FB}=V_{REF}\times 105\%$		200		μΑ
Shutdown Current	I _{SHDN}	EN=0		5	10	μA
Feedback Reference Voltage	V _{REF}		591	600	609	mV
FB Input Current	I _{FB}	$V_{FB}=3.3V$	-50		50	nA
Top FET R _{ON}	R _{DS(ON)1}			130		mΩ
Bottom FET R _{ON}	R _{DS(ON)2}			105		mΩ
EN Rising Threshold	V _{EN, R}		1.08	1.2	1.32	V
EN Falling Threshold	V _{EN, F}		0.9	1.0	1.1	V
Min ON Time	t _{ON,MIN}			50		ns
Min OFF Time	t _{OFF,MIN}			100		ns
Turn On Delay	t _{ON,DLY}	from EN high to LX start switching		300		μs
Soft-start Time	t _{SS}	V_{OUT} from 0 to 100%		1		ms
Switching Frequency	\mathbf{f}_{SW}	I _{OUT} =1A		500		kHz
Top FET Current Limit	$I_{LMT,TOP}$		3			А
Bottom FET Current Limit	I _{LMT,BOT}		2			А
Output Under Voltage Protection Threshold	V_{UVP}			0.33		V _{REF}
Output UVP Delay	t _{UVP,DLY}			200		μs
UVP Hiccup On Time	t _{UVP,ON}			1.4		ms
UVP Hiccup Off Time	t _{UVP,OFF}			5.2		ms
Thermal Shutdown Temperature	T_{SD}			150		°C
Thermal Shutdown Hysteresis	T _{HYS}			15		°C

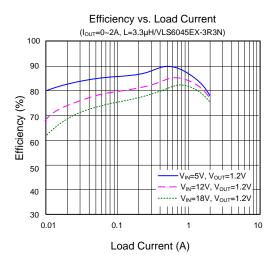
Note 1: Stresses beyond the "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

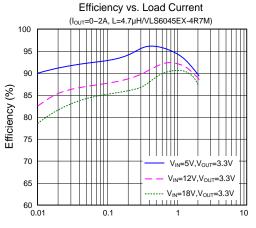
Note 2: θ_{JA} is measured in the natural convection at $T_A = 25 \text{ }^{\circ}\text{C}$ on a 2OZ two-layer Silergy evaluation board. Paddle of SOT23-6 package is the case position for SY81052 θ_{JC} measurement.

Note 3: The device is not guaranteed to function outside its operating conditions.

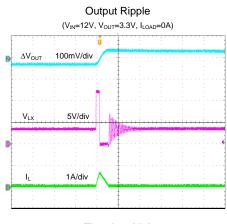


Typical Performance Characteristics

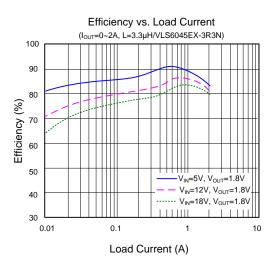


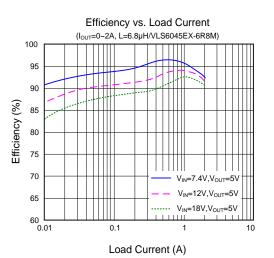


Load Current (A)



Time (2µs/div)

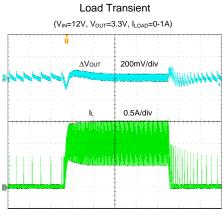




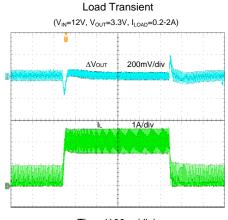
Output Ripple (VIN=12V, VOUT=3.3V, ILOAD=2A)



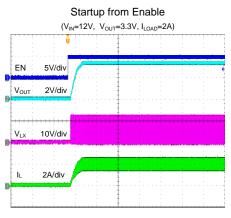
SY81052



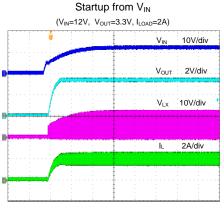
Time (100µs/div)



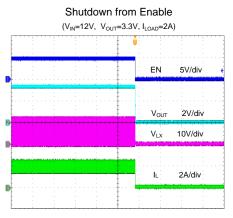
Time (100µs/div)



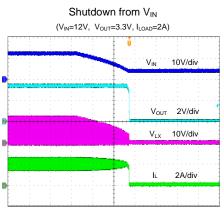
Time (2ms/div)



Time (2ms/div)



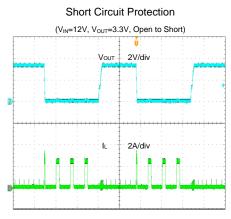
Time (2ms/div)



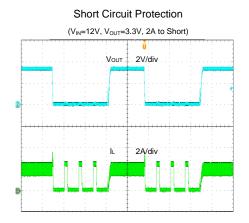
Time (2ms/div)



SY81052



Time (10ms/div)



Time (10ms/div)



Operation

The SY81052 is a high efficiency, 500kHz synchronous step-down DC/DC regulator capable of delivering up to 2A load current. It can operate over a wide input voltage range from 4.2V to 18V and integrate main switch and synchronous switch with very low $R_{DS(ON)}$ to minimize the conduction loss. The SY81052 adopts the instant PWM architecture to achieve fast transient responses for high step down applications and high efficiency at light loads.

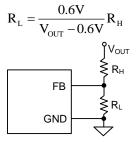
The SY81052 provides protection functions such as cycle by cycle current limiting and thermal shutdown protection. The SY81052 will sense the output voltage conditions for the fault protection.

Applications Information

Because of the high integration in the SY81052, the application circuit based on this regulator is rather simple. Only input capacitor C_{IN} , output capacitor C_{OUT} , output inductor L and feedback resistors (R_H and R_L) need to be selected for the targeted applications specifications.

Feedback Resistor Dividers RH and RL

Choose R_H and R_L to program the proper output voltage. To minimize the power consumption under light loads, it is desirable to choose large resistance values for both R_H and R_L . A value of between $10k\Omega$ and $1M\Omega$ is highly recommended for both resistors. If V_{OUT} is 3.3V, $R_H=100k$ is chosen, then using following equation, R_L can be calculated to be 22.1k:



Input Capacitor CIN

The ripple current through input capacitor is calculated as:

 $I_{\text{CIN_RMS}} {=} I_{\text{OUT}} \times \sqrt{D(1{\text{-}}D)}$

Place a typical X5R or a better grade ceramic capacitor really close to the IN and GND pins to minimize the potential noise problem. Care should be taken to minimize the loop area formed by C_{IN} , and IN/GND pins. In this case, a 10μ F low ESR ceramic capacitor is recommended.

Output Capacitor Cout

The output capacitor is selected to handle the output ripple noise requirements. Both steady state ripple and transient requirements must be taken into consideration when selecting this capacitor. For the best performance, it is recommended to use X5R or a better grade ceramic capacitor with 16V rating and more than $10 \,\mu\text{F}$ capacitance.

Output Inductor L

There are several considerations in choosing this inductor.

1) Choose the inductance to provide the desired ripple current. It is suggested to choose the ripple current to be about 40% of the maximum output current. The inductance is calculated as:

$$L = \frac{V_{\text{OUT}}(1 - V_{\text{OUT}}/V_{\text{IN,MAX}})}{f_{\text{SW}} \times I_{\text{OUT,MAX}} \times 40\%}$$

Where fsw is the switching frequency and $I_{\text{OUT,MAX}}$ is the maximum load current.

The SY81052 is quite tolerant of different ripple current amplitude. Consequently, the final choice of inductance can be slightly off the calculation value without significantly impacting the performance.

2) The saturation current rating of the inductor must be selected to be greater than the peak inductor current under full load conditions.

Isat, min > Iout, max +
$$\frac{V_{OUT}(1-V_{OUT}/V_{IN,MAX})}{2 \times f_{SW} \times L}$$

3) The DCR of the inductor and the core loss at the switching frequency must be low enough to achieve the desired efficiency requirement. It is desirable to choose an inductor with DCR<50m Ω to achieve a good overall efficiency.

Minimum Duty Cycle and Maximum Duty Cycle

In the COT architecture, there is no limitation for small duty cycles, since even at very low duty cycles, the switching frequency can be reduced as needed once the on-time is close to the minimum on time, to always ensure a proper operation.

The device can support at least 88.78% maximum duty cycle operation under -40° C ~ 125° C condition.

In PFM light load operation, when the duty cycle is up to maximum duty cycle limitation, the device will enter into CCM operation even though the load current is null.

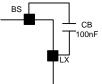


<u>Soft-start</u>

The SY81052 has a built-in soft-start to control the rise rate of the output voltage and limit the input current surge during the IC start-up. The typical soft-start time is 1ms.

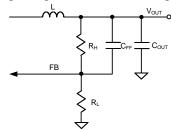
External Bootstrap Cap

This capacitor provides the gate driver voltage for internal high side MOSFET. A 100nF low ESR ceramic capacitor connected between BS pin and LX pin is recommended.



Load Transient Considerations

The SY81052 integrates the compensation components to achieve good stability and fast transient responses. Adding a small ceramic capacitor in parallel with R_H will further speed up the load transient responses.

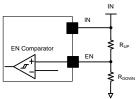


OCP and SCP Protection Method

If the high side power FET current gets higher than peak current limit threshold, the high side power FET will turn off and the low side power FET will turn on. If the low side FET current gets higher than valley current limit threshold, the low side FET will keep turning on until low side FET current decreases below the valley current limit threshold. So both peak and valley current are limited. If the load current continues to increase in these conditions, the output voltage will drop. When the output voltage falls below 33% of the regulation level, the output short will be detected and the IC will operate in hic-cup mode. The hic-cup on time is 1.4ms and hic-cup off time is 5.2ms. If the hard short is removed, the IC will return to normal operation.

Enable and Adjusting Under Voltage Lockout

The EN pin has accurate rising and falling threshold, it provides programmable ON/OFF control by connecting an external resistor divider. Once the EN pin voltage exceeds the rising threshold, the device starts operation. If the EN pin voltage is pulled below the falling threshold, the regulator will stop switching and enter shutdown state.



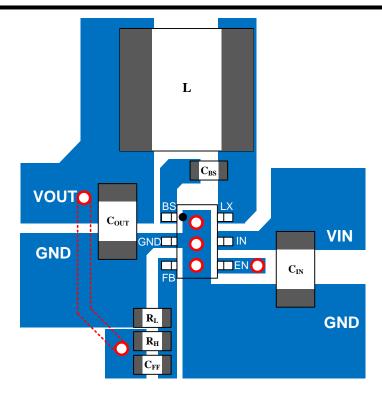
It is not recommended to connect EN and IN directly. A resistor in a range of $1k\Omega$ to $1M\Omega$ should be used if EN is pulled high by IN.

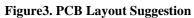
Layout Design

The layout design of the SY81052 is relatively simple. For the best efficiency and minimize the noise problem, we should place the following components close to the IC: C_{IN} , L, R_{H} and R_{L} .

- 1) It is desirable to maximize the PCB copper area connecting to the GND pin to achieve the best thermal and noise performance. If the board space allows, a ground plane is highly desirable.
- C_{IN} must be close to the IN and the GND pins. The loop area formed by C_{IN} and GND must be minimized.
- 3) The PCB copper area associated with the LX pin must be minimized to avoid the potential noise problem.
- The components R_H and R_L, and the trace connecting to the FB pin must NOT be adjacent to the LX net on the PCB layout to avoid the noise problem.
- 5) If the system chip interfacing with the EN pin has a high impedance state at shutdown mode and the IN pin is connected directly to a power source such as a Li-Ion battery, it is desirable to add a pull down $1M\Omega$ resistor between the EN and the GND pins to prevent the noise from falsely turning on the regulator at shutdown mode.

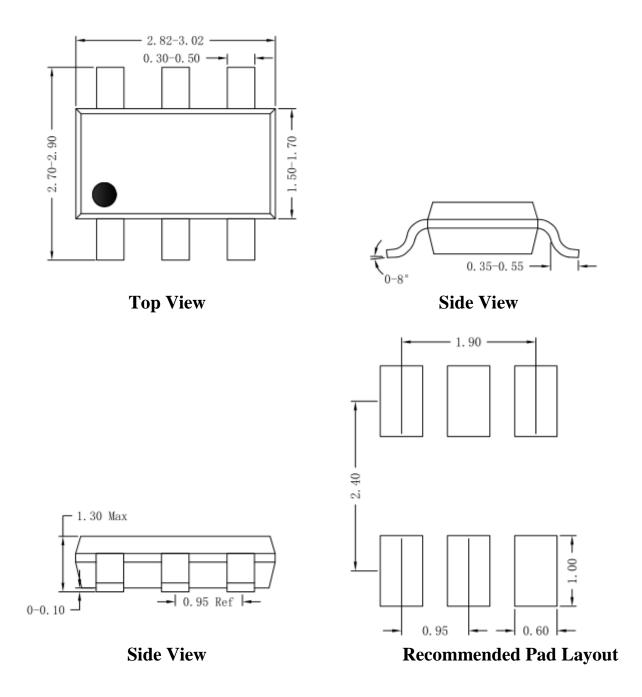










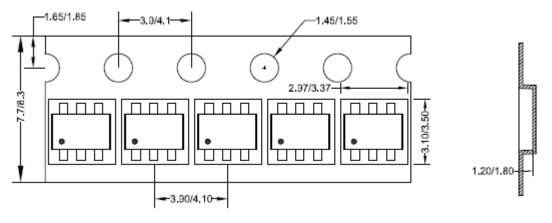


Notes: All dimension in millimeter and exclude mold flash & metal burr.



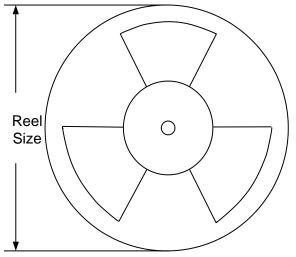
Taping & Reel Specification

1. Taping orientation for package



Feeding direction ——

2. Carrier Tape & Reel specification for packages



Package	Tape width	Pocket	Reel size	Trailer	Leader length	Qty per
type	(mm)	pitch(mm)	(Inch)	length(mm)	(mm)	reel
SOT23-6	8	4	7''	280	160	3000

3. Others: NA



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